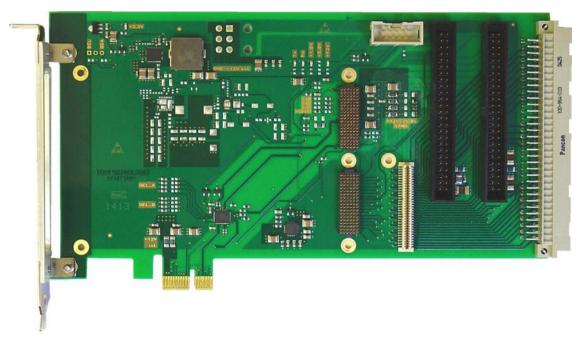


TPCE275 PCI Express x1, Gen1 XMC Carrier



TPCE275-10R

Application Information

The TPCE275 is a standard height PCI Express Revision 1.1 compatible module that provides one slot for a single-width XMC module used to build modular, flexible and cost effective I/O solutions for all kinds of applications like process control, medical systems, telecommunication and traffic control.

The TPCE275 is a versatile solution to upgrade well known XMC I/O solutions to the PCI Express signalling standard.

The PCI Express x1 link from the host board to the XMC module is enhanced by a PCIe Redriver, allowing safe operation of XMC modules on PCIe mainboards.

VPWR is selectable via order option. The TPCE275-x0R variants provide for 12V VPWR and the TPCE275-x1R order options provide 5V VPWR.

The TPCE275 supports XMC front panel I/O, and also P14 and P16 rear I/O independently.

XMC P14 rear I/O is provided through a VME P2 style connector (IEC 60603-2, Type C). The I/O mapping of P14

complies with VITA-35 ("PMC P4 to VME-P2, Rows A-C mapping").

XMC P16 rear I/O is provided through two 50-pin flat cable connectors mounted in a 2.54mm grid.

The PCIe edge card connector provides +12V and +3.3V. The TPCE275-1xR uses the +12V of the PCIe edge card connector to generate all power supply voltages for the XMC slot (+3.3V, VPWR and +12V).

According to the PCIe specification, a PCIe x1 card is limited to 6W on the +12V which allows to operate many of the available XMC modules on the TPCE275-1xR. For increased power requirements of an XMC module, the TPCE275-2xR offer a PCIe Graphics Power Connector to supply the +12V for generating all the power supply voltages for the XMC slot providing power of up to 25W.

A 10-pin JTAG header is available for XMC module debugging purposes. All five JTAG signals are routed directly to the XMC slot.



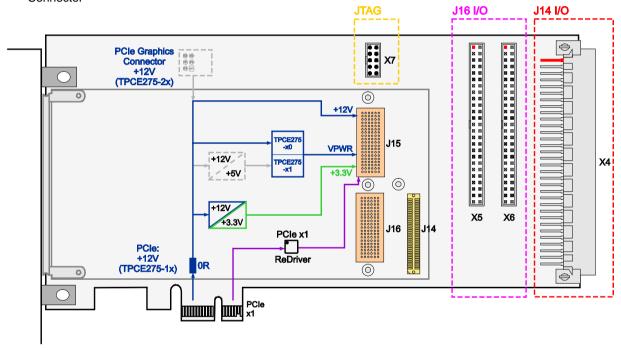
The Embedded I/O Company

Technical Information

- O Form Factor: PCI Express x1, Revision 1.1
 - O Board size: approx. 200mm x 111mm
- One XMC Slot:
 - O PCle Interface: x1, Rev. 1.1
 - O XMC Front Panel I/O
 - XMC P14 I/O connected to VME P2 Style Connector (IEC 60603-2 compatible)
 - O XMC P16 I/O connected to two 50-pin flat cable connectors
- O All XMC Power Supplies generated from +12V
 - O TPCE275-1xR: +12V from PCIe edge card connector
 - TPCE275-2xR: +12V from PCIe Graphics Power Connector

-) JTAG:
 - 10-pin header with all five JTAG signals routed to XMC connector
- O Operating temperature: 0°C to +70°C
- O MTBF (MIL-HDBK217F/FN2 G_B 20°C):

TPCE275-10R: 664000h TPCE275-11R: 664000h TPCE275-20R: 637000h TPCE275-21R: 637000h



Order Information

RoHS Compliant

TPCE275-10R 1 Slot XMC Carrier, PCle x1, VPWR = 12V, 12V from PCle connector **TPCE275-11R** 1 Slot XMC Carrier, PCle x1, VPWR = 5V, 12V from PCle connector

TPCE275-20R 1 Slot XMC Carrier, PCIe x1, VPWR = 12V, 12V from PCIe Graphics connector **TPCE275-21R** 1 Slot XMC Carrier, PCIe x1, VPWR = 5V, 12V from PCIe Graphics connector

For the availability of non-RoHS compliant (leaded solder) products please contact TEWS.

Documentation

TPCE275-DOC User Manual